

TD(H)341S232H DFN package isolated RS232 Transceiver

Features

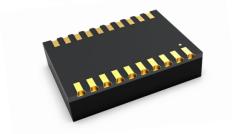
- Ultra-small, ultra-thin, chip scale DFN package
- · Compliant with TIA/EIA-232 standard
- Integrated isolated 3.3V power
- I/O power supply range supports 3.3V microprocessors
- High isolation to 5000VDC (TD341S232H 3000VDC)
- Bus-Pin ESD protection up to 15kV(HBM)
- Baud rate up to 120kbps
- >25kV/us CMTI
- Industrial operating ambient temperature range: -40 °C to +85 °C
- Meet AEC-Q100 standards
- EN62368 approval
- Moisture Sensitivity Level (MSL) 3

Applications

- Industrial Automation
- Building Automation
- Smart Electricity Meter

Package





Functional Description

TD(H)341S232H is a RS232 transceiver with low power consumption and high electrostatic protection and ESD protection, and it is fully compliant with TIA/EIA-232 standards. The main function of the product will be to convert the TTL level to the level of the RS232 protocol to achieve signal isolation. And the product comes with a constant voltage isolation power supply, which can achieve 3000/5000VDC electrical isolation, and can also be easily embedded in user equipment, so that the equipment can easily realize the connection function of the RS232 protocol network.

TD(H)341S232H focuses on strengthening the reliability design of T_{OUT} and R_{IN} pins and enhanced ESD design on the basis of traditional IC. Its T_{OUT} and R_{IN} port ESD tolerance is as high as 15kV (Human Body Model).

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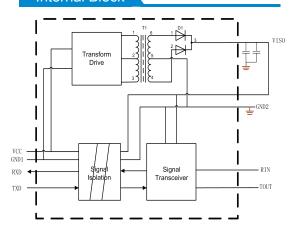
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Pin Connection

NC	1		20 VISO
VCC	2		19 V ₊
VCC	3		18 C1 ₊
GND_1	4		17 C1
GND_1	5	Top View	16 TOUT
GND_1	6	lop view	15 RIN
GND_1	7		14 C2 ₊
RXD	8		13 C2
TXD	9		12 V.
GND_1	10		11 GND ₂

Note: All GND_1 pins are internally connected.

Internal Block



Function Table

Letter	Description
Н	High-Level
L	Low-Level

Table 1. Driver Function table

Transceiver function	Input	Output	
	TXD	T_OUT	
Send function	L	Н	
	Н	L	

Table 2. Receiver Function table

Transceiver function	Input	Output			
	R_IN	RXD			
Receive function ①	≥2.4V	L			
Receive function(1)	≤0.6V	Н			
	0.6V≤RXD≤2.4V	Uncertainty			
Note: ①The receiving threshold varies slightly with Vcc.					

Pin Descriptions

Pin Number	Pin Name	Pin Functions
1	NC	No function pin, can be left floating.
2	V _{CC}	Power supply. By using 1uF ceramic capacitance ground(GND ₁).
3	V _{CC}	Power supply. By using 1uF ceramic capacitance ground(GND ₁).
4	GND₁	Logic side reference ground.
5	GND₁	Logic side reference ground.
6	GND₁	Logic side reference ground.
7	GND₁	Logic side reference ground.
8	RXD	Receiver signal output pin.
9	TXD	Driver input pin.
10	GND₁	Logic side reference ground.
11	GND ₂	Isolated output reference ground.
12	V-	Negative power generated internally,this pin is recommended to be connected to the isolated output reference ground(GND ₂) through a 0.1uF capacitor.
13,14	C2-,C2+	The positive and negative connections of the charge pump capacitor. These two pins are connected to an external capacitor C2, 0.1uF capacitor is recommended.
15	R _{IN}	Receiver input. This input accepts RS-232 signal level.
16	T _{OUT}	Drive output. This pin outputs the RS-232 signal level.
17,18	C1-,C1+	The positive and negative connections of the charge pump capacitor. These two pins are connected to an external capacitor C1, and a 0.1uF capacitor is recommended.
19	V+	Positive power generated internally, this pin is recommended to be connected to the isolated output reference ground(GND ₂) through a 0.1uF capacitor.
20	V _{ISO}	Isolated power output terminal, this pin must be connected to the isolated output reference ground(GND ₂) through a 1uF capacitor.

Absolute Maximum Ratings

General test conditions: Free-air, normal operating temperature range (Unless otherwise specified).

Parameters	Unit
Supply voltage	-0.3V to +3.5V
Driver input pin,TXD	-0.3V to +3.5V
Driver output pin,T _{OUT}	-13.2V to +13.2V
Receiver input pin,R _{IN}	-25V to +25V
Receiver output pin,RXD	-0.3V to +3.5V
Operating Temperature Range	-40°C to +105°C
Storage Temperature Range	−50°C to +150°C
Reflow Soldering Temperature	Peak temp. ≤250°C, maximum duration ≤60s at 217°C. Please also refer to IPC/JEDEC J-STD-020D. 3.

Important: Exposure to absolute maximum rated conditions for an extended period may severely affect the device reliability, and stress levels exceeding the "Absolute Maximum Ratings" may result in permanent damage. All voltage values are based on the reference ground(GND).

Recommended Operating Conditions

Symbol	Recommend an operate condition		Min.	Тур.	Max.	Unit
Vcc	Supply voltage		3.15	3.3	3.45	
V _{IH}	High-level input voltage(TXD)		2		Vcc	V
VIL	Low-level in	out voltage(TXD)	0		0.8	
	Output current	Driver	2			- mA
los		Receiver			10	
R∟	Output load resistance			3k		Ω
T _A	Operating temperature range		-40		85	$^{\circ}$
-	Sign	aling rate			120	kbps

Electrical Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Driver			•	1	'	
	Drive output high level	R_L =3k Ω to GND_2	5	7		V
V_{TOUT}	Drive output low level	R_L =3k Ω to GND_2		-7	-5	V
R _{TOUT}	Driver output impedance		300			Ω
I _{tsc}	Driver short circuit current				60	mA
Receiver			•		'	
VRIN	Receiver input range		-25		25	V
VRIL	Receiver input low threshold voltage		0.6	0.9		V
VRIH	Receiver input high threshold voltage			1.5	2.4	V
	Receiver input hysteresis			0.4		V
R_{RIN}	Receiver input impedance		3	5	7	$k\Omega$
VROH	RXD high level output voltage		Vcc - 0.4	Vcc - 0.1		V
Vrol	RXD low level output voltage				0.4	V
Power supply	and safeguard characteristic					
Icc	Supply current			25	35	mA
	Marking ourrent	No load		30	45	mA
I _{CC}	Working current	R_L =3k Ω to GND_2		30	45	mA
	LIDM	T _{OUT} 、R _{IN} to GND ₂			±15	kV
ESD	HBM	Other pin			±2	kV
	Contact	T _{OUT} 、R _{IN} to GND ₂			±8	kV
EFT	IEC61000-4-4	T _{OUT} 、R _{IN} to GND₂			±2	kV
SURGE	IEC61000-4-5	Tout、Rin to GND ₂			±2	kV
	Inquisto voltago	TD341S232H			3000	VDC
\/I \	Insulate voltage	TDH341S232H			5000	VDC
VI-O	Insulate impedance		1			GΩ
	Insulate capacitance			50		pF
CMTI	Common mode transient immunity	TXD = V_{CC} or 0 V, V_{CM} = 1 kV, transient magnitude = 800 V	25			kV/us

Note: ESD indicators are non-charged test specifications, GND2 need to be connected to the earth during testing.

Transmission Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
-	Maximum data rate	Duty 40% ~ 60%			120	kbps
T _{PHL} , T _{PLH}	Driver propagation delay	R_L = $3k\Omega$ to $7k\Omega$, C_L = $50pF$			2	us
T _{PHL} , T _{PLH}	Receiver propagation delay	C _L = 15pF			2	us

Physical Specifications

Parameters	Value	Unit
Weight	1.0(Typ.)	g

Typical Performance Curves

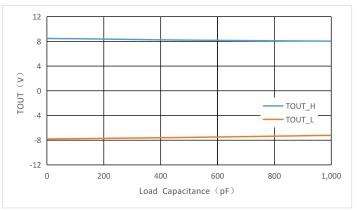


Figure 1. Transmitter Output Voltage High/Low VS Load Capacitance at 120 kbps

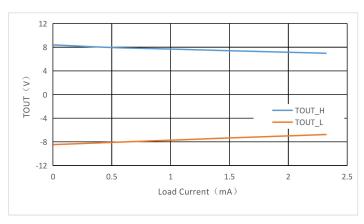


Figure 2. Transmitter Output Voltage High/Low VS Load Current

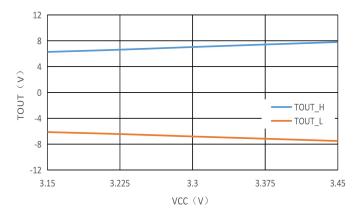


Figure 3. Transmitter Output Voltage High/Low VS V_{CC} , R_L =3 $k\Omega$

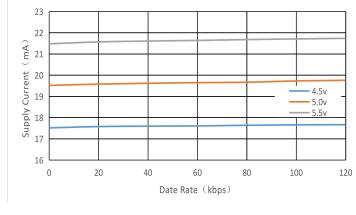


Figure 4. Supply current VS Data rate

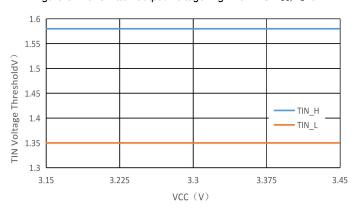


Figure 5. TIN Voltage Threshold VS V_{CC}

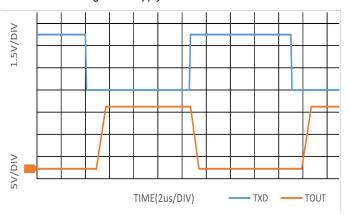


Figure 6. 120kbps Date Transmission(V_{CC} =3.3V, R_L =3 $k\Omega$)

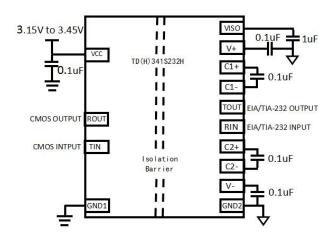


Figure 7. The typical model applies telephone

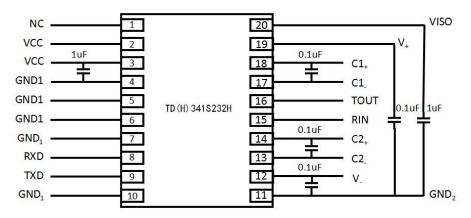


Figure8. Type PCB layout

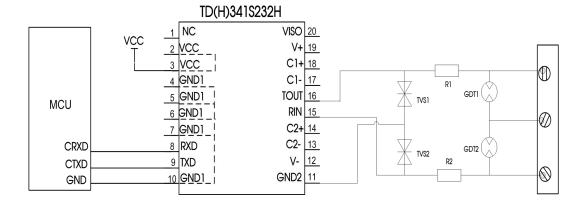


Figure 9. Port protection circuit for harsh environments

Recommended components and values:

Components	TD341S232H	TDH341S232H				
TVS1, TVS2	SMCJ15CA					
R1, R2	12Ω/2W(Wire-wound resistor)					
GDT1, GDT2	S30-	A90X				

When the module is used in applications with harsh environment, it can be susceptible to large energy like lightning strike, etc. in which case, it is essential to add an adequate protection circuit to the 232 signal ports to protect the system from failure and maintain a reliable bus communication. Figure 9 provides a recommended protection circuit design for high-energy lightning surges, with a degree of protection related to the selected protection

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device. Parameter description lists a set of recommended circuit parameters, which can be adjusted according to the actual application situation. Also, when using the shielded cable, the reliable single-point grounding of the shield must be achieved.

Note: The recommended components and values is a general guideline only and must be verified for the actual user's application.

Recommendations

- ①The power supply is not recommended for other purposes, otherwise it may cause the bus voltage did not meet the requirements of communication, causes the communication failure.
- ②Hot-swap is not supported.
- ③If the external input of TXD is insufficient, the pull-up resistor should be added according to the situation.
- (4) Refer to IPC 7093 for the welding process design of this product. For detailed operation guidance, please refer to Hot Air Gun Welding Operation Instruction for DFN Package Product or Welding Operation Instruction for DFN Package Product.

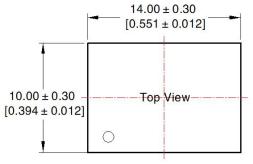
Ordering Information

Part number	Package	Number of pins	Product marking	Tape & Reel	
TD341S232H	DFN	20	TD341S232H	300/REEL	
TDH341S232H	DFN	20	TDH341S232H	300/REEL	

THIRD ANGLE PROJECTION -



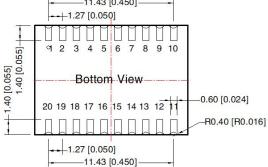




 $-\frac{3.10 \pm 0.30}{[0.122 \pm 0.012]}$

Note: Grid 2.54*2.54mm

0.30 [0.012] Front View
0.30 [0.012] - 11.43 [0.450]

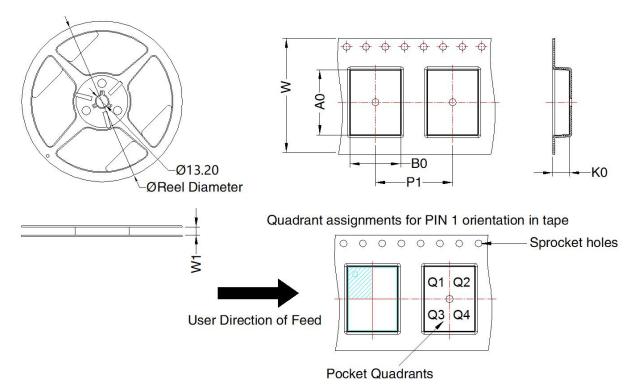


Note:

Unit: mm[inch]

General tolerances: $\pm 0.10[\pm 0.004]$

	Pin-Out								
Pin	Mark	Pin	Mark						
1	NC	11	GND ₂						
2	Vcc	12	V-						
3	Vcc	13	C2-						
4	GND₁	14	C2+						
5	GND ₁	15	RIN						
6	GND₁	16	Тоит						
7	GND₁	17	C1-						
8	RXD	18	C1+						
9	TXD	19	V+						
10	GND₁	20	Viso						



Device	Package Type	Pin	MPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TD(H)341S232H	DFN 10x14	20	300	180.0	24.4	14.52	10.52	3.5	16.0	24.0	Q1

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